U.S. PTO 11/790125

04/24/2007

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[FORM PTO-1595 RECORDATION FORM (Rev. 08/05)	1 COVER SHEET
	Docket No.: 069576-0238 PATENTS	ONLY 103403591
Ö	To the Director of the U. S. Patent and Trademark Office: Please r	ecord the attached docu
	1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)
1	Jaeun YOO, Hyung Soo AHN, Min YANG, Masayoshi	Name: SAMSUNG ELECTRO-MECHANICS CO., LTD.
••	KOIKE	
エ		
	Additional name(s) of conveying party(ies) attached? Yes No	
	3. Nature of Conveyance/Execution Date(s)	Address: 314, Maetan3-Dong, Yeongtong-Gu, Suwon
-	Execution Date(s): April 11, 2007	
		Gyunggi-Do, REPUBLIC OF KOREA
	☐ Security Agreement ☐ Change of Name	
	☐ Joint Research Agreement	
	Government Interest Assignment	
	Executive Order 9424, Confrmatory License	
	Other	Additional name(s) & address(es) attached? Yes No
	4. Application or patent number(s):	☐ This document is being filed together with a new application
	A. Patent Application No(s).	B. Patent No(s).
	• •	
	Additional numbers attac	hed? 🗌 Yes 🔲 No
	5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
	Name: MCDERMOTT WILL & EMERY LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00
	Internal Address:	Authorized to be charged by credit card
		Authorized to be charged to deposit account
	Street Address: 600 13th Street, N.W.	☐ Enclosed
		None required (government interest not affecting title)nt
	City: Washington State: D. C. Zip: 20005-3096	
	Phone Number: 202.756.8000	8. Payment Information:
	Fax Number: 202.756.8087	
	Email Address:	a. Credit Card Last 4 Numbers
/		Expiration Date
05/0	8/2007 DBYRNE 00000186 500417 11790125	b. Deposit Account Number 500417
01 F	C:8021 40.00 DA	Authorized User Name
	9. Signature.	-1000
,	Stephen A. Becker, 26,527	April 24, 2007
	Name and Registration No. of Person Signing	Signature Date
	Total number of pages including	ng cover sheet, attachments and documents:
	OMB No. 0651-0027 (exp. 6/30/2008)	

PATENT REEL: 019278 FRAME: 0091

(SAB)	
Docket No.:	ASSIGNMENT
In consideration of the premises and of sufficiency of which is hereby acknowledged, the u	her good and valuable consideration in hand paid, the receipt are indersigned,
	5)
	6)
	7)
(4) Masayoshi KOIKE (8)
who have made a certain new and useful invention, SAMSUNG ELECTRO-MECHANICS CO., LTD.	
314, Maetan3-Dong, Yeongtong-Gu, Suwon, Gyun	ggi-do, Republic of Korea
its successors and assigns (hereinafter designated "America as defined in 35 U.S.C. 100 in the invention METHOD OF FORMING NITRIDE FILM AND	ASSIGNEE") the entire right, title and interest for the United States con entitled D NITRIDE STRUCTURE
(a) for which an application for United States Let	ters Patent was filed on
and identified by United States Serial No.	
(b) for which an application for	United States Letters Patent was executed or
on behalf of said ASSIGNEE; AND the undersigned hereby agree to transplication for and obtaining original, divisional, rethe said ASSIGNEE, its successors, assigns and leimprovements, and applications for patent based the	
INVENTORS	DATE SIGNED
1./A.D.	
1) jaeun 2/00	2007.4.11
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3) N. Tarre	
Name: Min YANG .	
4) Mikoik	2007. 4.11
Name: Masayoshi KOIKE	
5)	
Name:	

RECORDED: 04/24/2007

PATENT REEL: 019278 FRAME: 0092